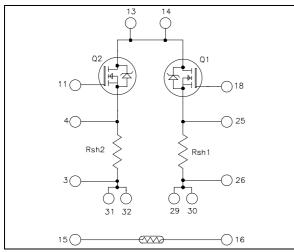
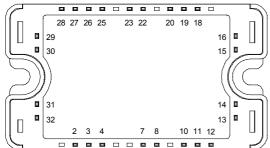


# APTML202UM18R010T3AG

# Linear MOSFET Power Module





Pins 13/14; 29/30; 31/32 must be shorted together

# $V_{DSS} = 200V$ $R_{DSon} = 18m\Omega$ typ @ Tj = 25°C $I_D = 109A^*$ @ Tc = 25°C

#### **Application**

• Electronic load dedicated to power supplies and battery discharge testing

#### **Features**

- Linear MOSFET
- Very low stray inductance
- Internal thermistor for temperature monitoring
- High level of integration
- AlN substrate for improved thermal performance

#### **Benefits**

- Direct mounting to heatsink (isolated package)
- easy series and parallels combinations for power and voltage improvements
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

#### Absolute maximum ratings (per leg)

| Symbol            | Parameter Parameter                                     |                     | Max ratings | Unit |
|-------------------|---|---------------------|-------------|------|
| $V_{ m DSS}$      | Drain - Source Breakdown Voltage                        |                     | 200         | V    |
| T                 | Continuous Drain Current                                | $T_c = 25^{\circ}C$ | 109*        |      |
| $I_D$             | Continuous Drain Current                                | $T_c = 80$ °C       | 81*         | A    |
| $I_{DM}$          | Pulsed Drain current                                    |                     | 400         |      |
| $V_{GS}$          | Gate - Source Voltage                                   |                     | ±30         | V    |
| R <sub>DSon</sub> | Drain - Source ON Resistance                            |                     | 19          | mΩ   |
| $P_{D}$           | Maximum Power Dissipation $\bullet$ $T_c = 25^{\circ}C$ |                     | 480         | W    |
| $I_{AR}$          | Avalanche current (repetitive and non repetitive)       |                     | 100         | A    |
| $E_{AR}$          | Repetitive Avalanche Energy                             |                     | 50          | mJ   |
| $E_{AS}$          | Single Pulse Avalanche Energy                           |                     | 3000        | 1113 |

- \* Output current per leg must be limited to 44A @ T<sub>C</sub>=25°C and 31A @ T<sub>C</sub>=80°C to not exceed the shunt specification.
- In saturation mode

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



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## All ratings @ $T_j = 25$ °C unless otherwise specified

## **Electrical Characteristics** (per leg)

| Symbol              | Characteristic                  | Test Conditions                          |                | Min | Typ | Max  | Unit |  |
|---------------------|---------------------------------|--|----------------|-----|-----|------|------|--|
| $I_{DSS}$           | Zero Gate Voltage Drain Current | $V_{DS} = 200V ; V_{GS} = 0V$            | $T_j = 25$ °C  |     |     | 25   | 4    |  |
|                     |                                 | $V_{DS} = 160V ; V_{GS} = 0V$            | $T_j = 125$ °C |     |     | 250  | μΑ   |  |
| R <sub>DS(on)</sub> | Drain – Source on Resistance    | $V_{GS} = 10V, I_D = 50A$                |                |     | 18  | 19   | mΩ   |  |
| $V_{GS(th)}$        | Gate Threshold Voltage          | $V_{GS} = V_{DS}, I_{D} = 2.5 \text{mA}$ |                | 2   |     | 4    | V    |  |
| $I_{GSS}$           | Gate – Source Leakage Current   | $V_{GS} = \pm 30 \text{ V}$              |                |     |     | ±100 | nA   |  |

## **Dynamic Characteristics** (per leg)

| Symbol    | Characteristic               | Test Conditions    | Min | Typ  | Max | Unit |
|-----------|------------------------------|--------------------|-----|------|-----|------|
| $C_{iss}$ | Input Capacitance            | $V_{GS} = 0V$      |     | 9880 |     |      |
| $C_{oss}$ | Output Capacitance           | $V_{\rm DS} = 25V$ |     | 2320 |     | pF   |
| $C_{rss}$ | Reverse Transfer Capacitance | f = 1MHz           |     | 700  |     |      |

### **Shunt Electrical Characteristics** (per leg)

| Symbol          | Characteristic   |                    |                    | Min | Тур | Max | Unit |
|-----------------|------------------|--------------------|--------------------|-----|-----|-----|------|
| $R_{sh}$        | Resistance value |                    |                    |     | 10  |     | mΩ   |
| $T_{sh}$        | Tolerance        |                    |                    |     | 2   |     | %    |
| $P_{sh}$        |                  | <sub>C</sub> =25°C |                    |     | 20  | W   |      |
| r <sub>sh</sub> |                  | To                 | <sub>C</sub> =80°C |     |     | 10  | VV   |
| $I_{sh}$        | Current capacity | To                 | =25°C              |     |     | 44  |      |
|                 |                  | To                 | =80°C              |     |     | 31  | Α    |

## **Temperature sensor PTC**

| Symbol           | Characteristic          |                   | Min   | Typ   | Max   | Unit  |
|------------------|-------------------------|-------------------|-------|-------|-------|-------|
| R <sub>25</sub>  | Resistance @ 25°C       |                   | 1980  |       | 2020  | Ω     |
| $R_{100}/R_{25}$ | Resistance ratio        | Tamb=100°C & 25°C | 1.676 | 1.696 | 1.716 |       |
| $R_{-55}/R_{25}$ | Resistance ratio        | Tamb=-55°C & 25°C | 0.48  | 0.49  | 0.50  |       |
| В                | Temperature coefficient |                   |       | 7900  |       | ppm/K |

### Thermal and package characteristics

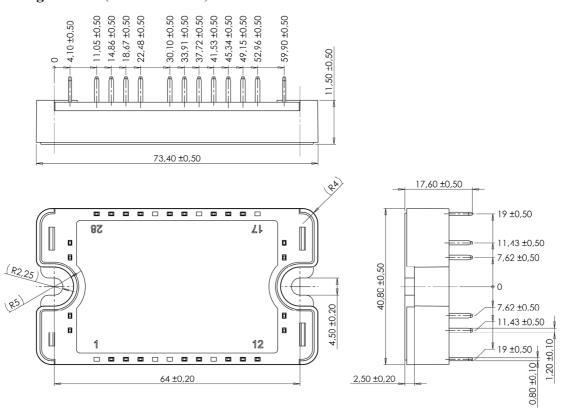
| Symbol           | Characteristic   |             |    | Min  | Typ | Max  | Unit |
|------------------|--|-------------|----|------|-----|------|------|
| $R_{thJC}$       | Junction to Case Thermal Resistance MOSFET (per leg)           |             |    |      |     | 0.26 | °C/W |
| $V_{ISOL}$       | RMS Isolation Voltage, any terminal to case t = 1 min, 50/60Hz |             |    | 4000 |     |      | V    |
| $T_{J}$          | Operating junction temperature range                           |             |    | -40  |     | 150  |      |
| T <sub>STG</sub> | Storage Temperature Range                                      |             |    | -40  |     | 125  | °C   |
| $T_{\rm C}$      | Operating Case Temperature                                     |             |    | -40  |     | 100  |      |
| Torque           | Mounting torque  | To heatsink | M4 | 2    |     | 3    | N.m  |
| Wt               | Package Weight   |             |    |      |     | 110  | g    |

2 - 4



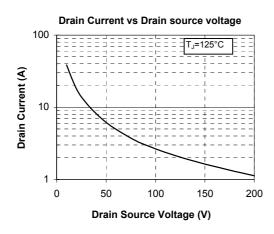
# **licrosemi** APTML202UM18R010T3AG

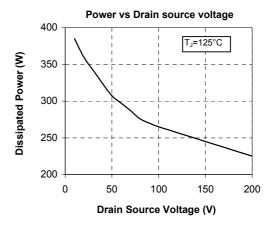
## SP3 Package outline (dimensions in mm)



See application note 1901 - Mounting Instructions for SP3 Power Modules on www.microsemi.com

#### Typical Performance Curve (linear mode) (per leg)







# APTML202UM18R010T3AG

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